

PRODUCT/PROCESS CHANGE NOTIFICATION (PCN)

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PCN #: A082100-2 Product Affected: PCI9080 Manufacturing Location Afford Date Effective: 08/01/00 Contact: Ted Rudolph Title: Quality Engineerin Phone: 408-328-3530 Fax #: 408-732-5916 E-mail: qa@plxtech.com	fected: Taiwan	MEANS OF DISTINGUISHING CHANGED DEVICES Product Mark Y Back Mark Date Code Y Other Additional Data: N/A Samples: N/A
Y Die Technology ■ Wafer Fabrication process Y Assembly Process Due to capacity constraints, PLX has qualified TSMC's Fab 9. This additional fab capacity will give PLX more flexibility in the manufacture of its PCI90803 to meet the increasing demands from our customers. The current fab (F2) is a 6" wafer fab And the additional fab (F9) is a 8" wafer fab. Consequently, in the future the PCI9080-3 may be manufactured in either fab. Part marking will identify the fab origin. Y Data Sheet		
RELIABILITY/QUALIFICATION SUMMARY: Reliability data will be available 10-31-2000		
CUSTOMER ACKNOWLEDGEMENT OF RECEIPT: Please use this acknowledgement below or E-mail qa@plxtech.com to grant approval or request additional information. If PLX does not receive acknowledgement within 30 days of this notice it will be assumed that this notice is acceptable.		
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